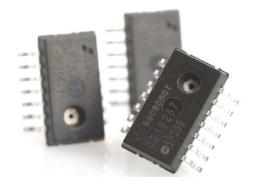
SP300-1(T), SP300-2(T)



SP300 Series Compensated Pressure Sensors With Embedded Microcontroller

The SP300 Pressure Sensor series represents Sensonor Technologies' most advanced pressure sensors. Based on already known technology, the SP300 adds a level of integration by including microcontroller and LF-input stages to meet market demands for flexible, customer specific behavior and solutions, and also resulting in over-all system cost reductions. The SP300 sensor is a micro system consisting of a micromachined sensor die and flexible ASIC, packaged in a low cost, plastic molded package (SOIC).

SP300 series has excellent media compatibility due to a patented bulk micromachined triple stack sensor die design, utilizing buried piezoresistive elements and backside media access to pressure diaphragm. With this design the internal connectors and piezoresistive elements of the pressure bridge are isolated from the measurement media. The isolation is of great advantage in terms of sensor stability and reliability over a very long lifetime.

The SP300 pressure sensor design has been proven in harsh environment applications during a period of more than 10 years, making these sensors ideal choices for demanding applications where reliable and accurate pressure measurements are required.

SP300-1 SP300-1T SP300-2 SP300-2T



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SENSONOR DATASHEET SP300 PRESSURE SENSOR SERIES

SP300-1(T), SP300-2(T)

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SP300-1(T), SP300-2(T)

1 Product Description

1.1 Features

- o RISC microcontroller
- $\circ \ \ \text{High flexibility}$
- Code protection
- o ROM library functions
- o 5 general purpose I/O pins
- On-chip RC oscillator
- Absolute pressure sensor
- o Calibrated and compensated
- Temperature and supply
- voltage measurements output

- Sensor self diagnosis
- Unique electronic sensor ID
- o 2 channel LF receiver for wireless applications (125 kHz)
- o High reliability and accuracy over lifetime
- o High media compatibility
- Wide temperature operating range
- \circ Low standby current (0.3 µA)
- Robust miniature surface mount package
- Tube connection option (for T version sensors)

1.2 Overview

The SP300 Pressure Sensor series is the most advanced pressure sensors from Sensonor Technologies. The SP300 offers a high level of integration by including a microcontroller, a set of predefined ROM library functions, signal conditioning and LF-input stage (enabling wireless wakeup and command and data reception) to meet market demands for flexible, customer specific solutions and overall system cost reduction.

The SP300 Pressure Sensor series have excellent media compatibility due to the patented bulk micro machined triple stack sensor design. It utilizes buried piezoresistive elements and backside media access. With this design, the piezo resistors will avoid contact with the measurement media.

The SP300-1(T) and SP300-2(T) measures absolute pressures up to 200kPa. In addition to pressure the sensor provides temperature and supply voltage measurements. By integrating these functions with an ASIC in one package, Sensonor Technologies has developed an attractive product for a broad range of advanced pressure sensor applications.

The accuracy, stability and reliability of the SP300 design have been proven in applications during a period of more than 10 years. The sensors are ideal choices for demanding measurements, also in harsh environment, or in applications where advanced solutions are needed for implementing reliable pressure measurements. The SP300 is packaged in a proven 14 pin, SOIC package that efficiently can be handled by automatic production lines. Some of the SP300 models features a tube connection to ease pressure connection.

SP300-1(T), SP300-2(T)

2 Product Characteristics

2.1 Measurement performance

2.1.1 Pressure measurement

The presented performance reflects the use of 11-bit measurement of pressure and 10-bit measurement of temperature.

| Parameter | Specif | ication | | Ambient conditions | | | |
|------------|---------------------|-------------|------------------|--------------------|----------|--|--|
| i alametei | Model Unit Typ | | Temperature [°C] | Pressure [kPa] | | | |
| Resolution | SP300-1 SP300-1T | kPa/ Isb | 0.25 | -40 to 125 | 0 to 100 | | |
| | SP300-2 SP300-2T | kPa/ Isb | 0.5 | -40 to 125 | 0 to 200 | | |
| Accuracy | SP300-1 | kPa | ±1.9 | 0 to 50 | 0 to 100 | | |
| | SP300-1T | kPa | ±2.3 | 50 to 70 | 0 to 100 | | |
| | | kPa | ±4.5 | -40 to 125 | 0 to 100 | | |
| | SP300-2 | kPa | ±2.0 | 0 to 50 | 0 to 200 | | |
| | SP300-2T | kPa | ±2.4 | 50 to 70 | 0 to 200 | | |
| | | kPa | ±4.6 | -40 to 125 | 0 to 200 | | |

2.1.2 Temperature measurement

The presented performance reflects the use of 10-bit measurement of temperature.

| Parameter | Specif | ication | Ambient conditions | |
|------------|--------|---------|--------------------|------------------|
| i arameter | Model | Unit | Тур | Temperature [°C] |
| Accuracy | All | °C | ±1.8 | -20 to 70 |
| | | °C | ±3.0 | -40 to 90 |
| | | °C | -1.8 / | 90 to 125 |
| | | C | 4.2 | |

2.1.3 Supply voltage measurement

The presented performance reflects the use of 9-bit measurement of supply voltage.

| Parameter | Specif | ication | | Ambient conditions | | |
|------------|--------|---------|-----|--------------------|--------------------------------|--|
| 1 arameter | Model | Unit | Тур | Temperature [°C] | VDD [V] | |
| Accuracy | All | mV | ±60 | -40 to 125 | V_{THR} to 3.6 ₁₎ | |

1) See section 2.7 for V_{THR} specification.

SP300-1(T), SP300-2(T)

2.2 Current consumption

| Parameter | | Spec | ification | | Ambient C | Conditions | Comments |
|----------------------------|-----|------|-----------|------|------------|------------|--|
| Parameter | Min | Тур | Max | Unit | Temp [°C] | Vdd [V] | Comments |
| Power down current | | 0.4 | 0.6 | μA | 25 | 3.0 | |
| Power down current | | 13 | 20 | μA | 125 | 3.0 | |
| IDLE current | | 30 | 50 | μA | 25 | 3.0 | |
| IDLE current | | 50 | 75 | μA | 125 | 3.0 | |
| RUN current | | 0.53 | 0.8 | mA | 25 | 3.0 | |
| RUN current | | 0.65 | 1.0 | mA | 125 | 3.0 | |
| Pressure measurement | | 4 | 12 | μAs | -40 to 125 | 2.1 to 3.6 | 11 bit A/D conversion, excl. temperature measurement |
| Temperature measurement | | 0.9 | 2.5 | μAs | -40 to 125 | 2.1 to 3.6 | 10 bit A/D conversion |
| Supply voltage measurement | | 0.3 | 2.5 | μAs | -40 to 125 | 2.1 to 3.6 | 9 bit A/D conversion |
| Peak current | | 1.6 | 2.5 | mA | 25 | 3.0 | Pressure measurement and 1 LF channel on, duration is 1280µs for 11 bit measurement for the peak current only. |
| 1 channel LF current | | 2.6 | 4.6 | μA | 25 | 3.0 | |
| 1 channel LF current | | 3.0 | 6.7 | μA | 125 | 3.0 | |
| 2 channel LF current | | 4.5 | 5.5 | μA | 25 | 3.0 | 2 nd LF channel is optional |
| 2 channel LF current | | 6.5 | 11 | μA | 125 | 3.0 | 2 nd LF channel is optional |
| Thermal shutdown current | | 18 | 25 | μA | 125 | 3.0 | |
| Thermal shutdown current | | 30 | 50 | μA | 150 | 3.0 | |

2.3 Tmax

 ϑ_{SHTD} represents the temperature at which the Thermal Shut-down function can be enabled and ϑ_{REL} represents the temperature at which the Master Reset state is released. The ϑ_{SHTD} is always higher than ϑ_{REL}

| Parameter | | Spec | ification | | Ambient C | Conditions | Comments |
|-------------------|-----|------|-----------|------|------------|------------|----------------------------|
| Farameter | Min | Тур | Max | Unit | Temp [°C] | Vdd [V] | |
| θ _{SHTD} | 102 | | 123 | °C | -40 to 175 | 2.1 to 3.6 | Thermal shutdown enable |
| 9 _{REL} | 100 | | 121 | °C | -40 to 175 | 2.1 to 3.6 | Master Reset release |

2.4 Vmin

The voltage at which the Vmin-circuit will return a low battery voltage status is specified in chapter 2.7.

| Parameter | | Spec | ification | | Ambient C | Conditions | Comments |
|-----------|-----|------|-----------|------|------------|-------------------------|---|
| Farameter | Min | Тур | Max | Unit | Temp [°C] | Vdd [V] | |
| Vmin | 2.0 | 2.1 | 2.2 | V | -40 to 125 | V_{THR} to 3.6 | See section 2.7 for V_{THR} specification |

SP300-1(T), SP300-2(T)

2.5 Clock sources

2.5.1 System clock (MCLK)

| Parameter | | Spec | ification | | Ambient C | conditions | Comments |
|----------------|-----|------|-----------|------|------------|------------|----------|
| Parameter | Min | Тур | Max | Unit | Temp [°C] | Vdd [V] | |
| MCLK frequency | 1.8 | 2.0 | 2.2 | MHz | -40 to 125 | 2.1 to 3.6 | |

2.5.2 Low Power (LP) oscillator

| Parameter | | Spec | ification | | Ambient C | onditions | Comments |
|------------------------|----------------------|---------|-----------|------|------------|------------|--------------------------|
| Farameter | Min | Тур | Max | Unit | Temp [°C] | Vdd [V] | Comments |
| T _{it} | 0.5, 1.0, 2.0 or 4.0 | | | S | -40 to 125 | 2.1 to 3.6 | Interval timer main tick |
| del _{2t} | 25, 5 | 0, 75 o | r 100 | ms | -40 to 125 | 2.1 to 3.6 | Delay to extra tick |
| LP oscillator accuracy | -20 | | 20 | % | -40 to 125 | 2.1 to 3.6 | |

2.5.3 External clock

| Parameter | | Spec | ification | | Ambient C | Conditions | Comments |
|----------------|-----|------|-----------|------|------------|------------|----------|
| Falameter | Min | Тур | Max | Unit | Temp [°C] | Vdd [V] | |
| External clock | | | 3.5 | MHz | -40 to 125 | 2.1 to 3.6 | |

2.6 LF input

Table 2.1 LF telegram

| Parameter | | Spec | ification | | Ambient C | conditions | Comments |
|---------------------|----------|---------|------------|-----------|-------------|---------------|--|
| Farameter | Min | Тур | Max | Unit | Temp [°C] | Vdd [V] | Comments |
| Modulation | | ASK | | | -40 to 125 | 2.1 to 3.6 | |
| Carrier frequency | 121.25 | 125 | 128.75 | kHz | -40 to 125 | 2.1 to 3.6 | |
| Preamble period | 4 | | | ms | -40 to 125 | 2.1 to 3.6 | |
| Data rate | 3.84 | 3.9 | 3.96 | kHz | -40 to 125 | 2.1 to 3.6 | |
| Settling time | | | 2 | ms | -40 to 125 | 2.1 to 3.6 | Time from LF interface is turned on by RISC to the LF interface is active |
| Detection threshold | | | 5 | mVp-p | -40 to 125 | 2.1 to 3.6 | |
| Input capacitance | | 10 | 12 | pF | -40 to 125 | 2.1 to 3.6 | |
| Input resistance | 500 | | | kΩ | -40 to 125 | 2.1 to 3.6 | |
| Other | The inpu | t signa | Is from th | e enablec | LF channels | are rectified | and real time summed |

Table 2.2 LF Carrier Detection

| Parameter | | Spec | ification | | Ambient C | Conditions | Comments |
|---|--------|------|-----------|-------|------------|------------|-------------------------------------|
| Farameter | Min | Тур | Max | Unit | Temp [°C] | Vdd [V] | Comments |
| Carrier frequency | 121.25 | 125 | 128.75 | kHz | -40 to 125 | 2.1 to 3.6 | |
| Maximum sensitivity not to | 4 | | | mVp-p | 0 to 90 | 2.1 to 3.6 | |
| detect, 2 amplifiers enabled | 3.5 | | | mVp-p | 90 to 125 | 2.1 to 3.6 | |
| | 3.5 | | | mVp-p | -40 to 0 | 2.1 to 3.0 | |
| | 2.9 | | | mVp-p | -40 to 0 | 3.0 to 3.6 | |
| Minimum sensitivity to | 10 | | | mVp-p | 0 to 90 | 2.1 to 3.6 | |
| detect, 2 amplifiers enabled | 12.2 | | | mVp-p | 90 to 125 | 2.1 to 3.6 | |
| | 12.2 | | | mVp-p | -40 to 0 | 2.1 to 3.6 | |
| Maximum sensitivity not to | | 0.8 | | mVp-p | -40 | 3.6 | Guaranteed by ASIC |
| detect, 3 amplifiers enabled | 0.25 | | | mVp-p | -40 | 2.1 to 3.0 | characterization |
| | 0.25 | | | mVp-p | 0 to 125 | 2.1 to 3.6 |] |
| Minimum sensitivity to detect, 3 amplifiers enabled | | | 2.5 | mVp-p | -40 to 125 | 2.1 to 3.6 | Guaranteed by ASIC characterization |

SP300-1(T), SP300-2(T)

2.7 Power-on reset

| Parameter | | Spec | ification | | Comments |
|--|-----|------|-----------|------|----------|
| Falameter | Min | Тур | Max | Unit | Comments |
| Power-on reset level, V _{THR} | 1.8 | 1.85 | 1.9 | V | |

2.8 Digital I/O

| Parameter | Specification | | | | Comments |
|---------------------|----------------------|-----|--------------------|------|----------------------|
| Farameter | Min | Тур | Max | Unit | Comments |
| Digital output high | V _{DD} -0.3 | | | V | At 1 mA load current |
| Digital output low | | | 0.3 | V | At 1 mA load current |
| Digital input high | $0.8 \cdot V_{DD}$ | | | V | |
| Digital input low | | | $0.2 \cdot V_{DD}$ | V | |
| Input current | | | ±1 | μA | |

3 Recommended Operating Conditions

| Parameter | | Specification | | | Comments | |
|---------------------|---------------------|------------------------|--|-----|----------|----------------------------|
| Farameter | Model | Model Min Typ Max Unit | | | | |
| Input pressure | SP300-1 SP300-1T | 0 | | 100 | kPa | |
| | SP300-2 SP300-2T | 0 | | 200 | kPa | |
| Supply voltage | | V_{THR} | | 3.6 | V | Unless otherwise specified |
| Ambient temperature | | -40 | | 125 | °C | |

4 Absolute Maximum Ratings

| Parameter | Specification | | | | Comments | |
|------------------------------------|---------------|-----|---------|------|---|--|
| Farameter | Min | Тур | Max | Unit | Comments | |
| Ambient temperature, operating | -40 | | 150 | °C | Max 24 hrs accumulated over life time | |
| Ambient temperature, storage | -40 | | 150 | °C | Max 1000 hours | |
| Transient temperature | | | 175 | °C | Max 3 min. Will withstand standard reflow | |
| | | | 175 | | soldering process (JEDEC JESD22-B102-C) | |
| Supply Voltage | -0.3 | | 4.0 | V | | |
| Input voltage | -0.3 | | Vdd+0.3 | V | | |
| Input current, any pin (DC) | -10 | | 10 | mA | | |
| Input current, any pin (transient) | -100 | | 100 | mA | | |
| Input current, LF pins | -1 | | 1 | mA | | |
| Maximum input pressure | | | 600 | kPa | | |
| ESD | ±2.0 | | | kV | Human body model AEC-Q100 | |
| | ±500 | | | V | Charge device model AEC-Q100 | |
| Latch Up | 100 | | | mA | AEC-Q100 | |

Stress beyond the absolute maximum ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the device.

SP300-1(T), SP300-2(T)

5 Electrical and peripheral units

5.1 System description

The SP300 sensor is a micro system consisting of two dies packaged in a low cost, plastic molded package as shown in Figure 6.1. The die shown to the left is a micro machined chip containing a pressure. The die to the right is the ASIC containing the remaining part of the micro system. A block diagram is shown in Figure 5.2.

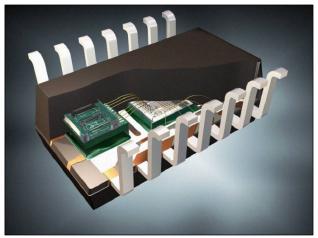


Figure 5.1 View of sensor internals

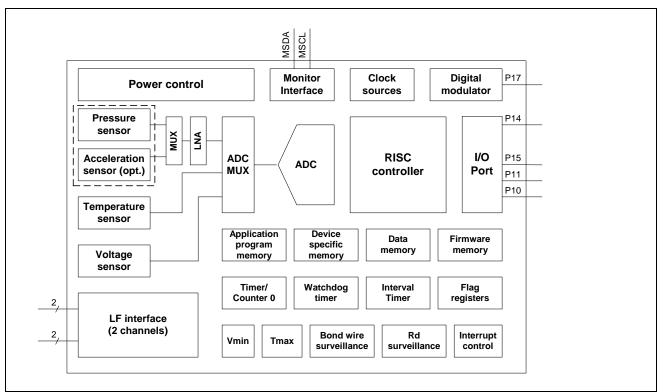


Figure 5.2 SP300 series block diagram

SENSONOF DATASHEET SP300 PRESSURE SENSOR SERIES

SP300-1(T), SP300-2(T)

5.2 RISC controller

The SP300 employs a low-power RISC (Reduced Instruction Set Computing) controller to control device operation according to an application program. The RISC is clocked from an on-chip RC oscillator, while the peripheral unit Timer/Counter 0 may be clocked from an external source, for example the reference clock of a PLL chip in case a higher precision or synchronous timing is desired.

The RISC features an 8 bit Harvard architecture with 16 bit instructions. Due to a two-stage pipeline concept the instructions execute in a single instruction cycle, featuring fast execution time and low-power consumption. The RISC block diagram is shown in Figure 6.3.

Byte-wise read access for the Application Program Memory is provided, whereas the firmware is not visible to the application program due to the implemented shadow mechanism. A software interrupt (SYS) allows the execution of library functions in ROM. The SYS mechanism handles the transition to the "shadowed" ROM.

The RISC features 128 byte of internal Data Memory. The Data Memory is also used as 16-bit program stack during subroutine calls and interrupts. Although no specific instructions are provided to manipulate this stack (e.g. Push/Pop), the RISC features auto-increment and auto-decrement addressing modes to enable data stack handling by the application program.

Peripherals of the RISC (timer, I/O, etc) are accessible via a Special Function Register File (SFR) that is mapped into the Data Address Space. The RISC allows byte-oriented as well as bit wise access to both Data Memory and SFR's. Eight general purpose registers (8 bit) are provided. Four of them may be used in the context of indirect addressing. Two of these registers provide additional post-increment and pre-decrement addressing modes in order to support e.g. a software data stack.

The ALU (Arithmetic Logic Unit) supports instructions for arithmetic, logical and Boolean data manipulation. The single priority level Interrupt Control system features an additional wakeup function from IDLE mode, which provides the application program with a convenient means to synchronize with the peripherals. A number of special loop control and bit shift instructions are available to optimize code speed and size.

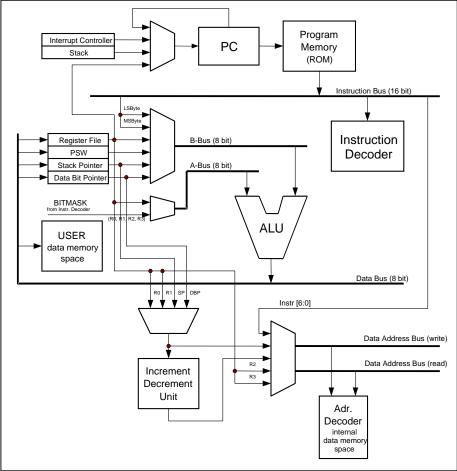


Figure 5.3 SP300 RISC controller block diagram

SP300-1(T), SP300-2(T)

6 Physical Dimensions and Marking

6.1 Physical Dimensions

The sensor package is a proven 14 pin, SOIC package that can be handled by automatic production lines.

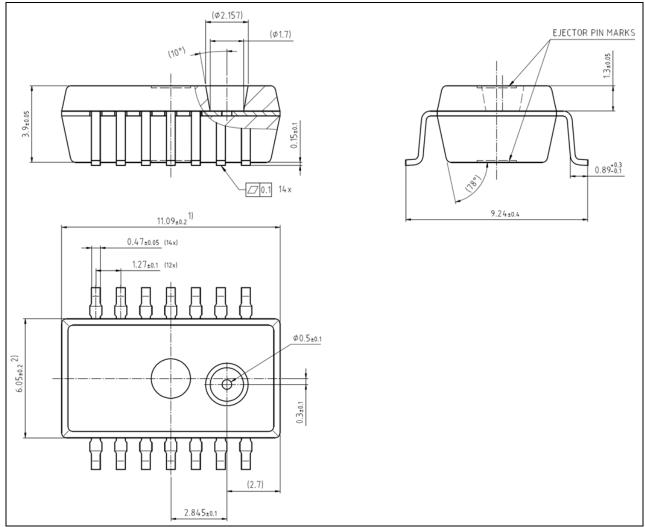


Figure 6.1 Physical dimensions drawing

- Dimension does not include mold flash, protrusions or gate burrs. Mold flash, protrusions and gate burrs do not exceed 0.15mm (0.006 inch) per side.
- Dimension does not include inter-lead flash or protrusions. Inter-lead flash and protrusions do not exceed 0.25mm (0.010 inch) per side.

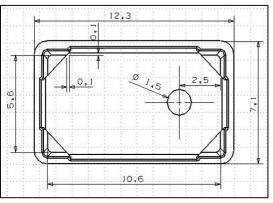
SP300-1(T), SP300-2(T)

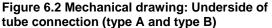
6.2 Tube Connection (option)

The SP300 models with 'T' in the model name features two different tube connection options to ease pressure connection.



Figure 6.3 Illustration of the SP300 series with tube connection (type A)





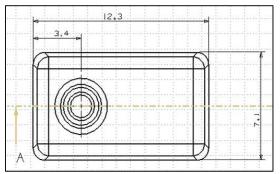
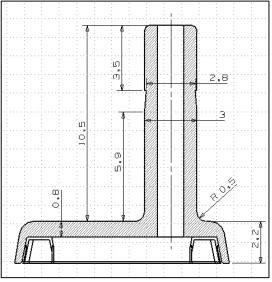
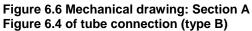


Figure 6.4 Mechanical drawing: Upside of tube connection (type A and B)





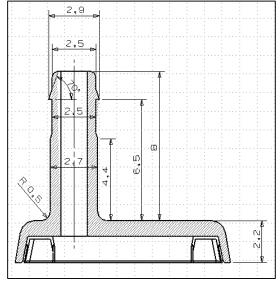
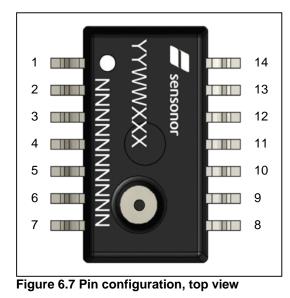


Figure 6.5 Mechanical drawing: Section A in Figure 6.4 of tube connection (type A)

SERIES SERIES SP300 PRESSURE SENSOR SERIES

SP300-1(T), SP300-2(T)

6.3 Pin Configuration



| Pin | Name | Function |
|-----|------|---|
| 1 | IN4 | LF receiver channel 2, negative input |
| 2 | P10 | General purpose I/O with external wakeup, internal pull-up/pull-down |
| 3 | P11 | General purpose I/O with external wakeup, internal pull-up/pull-down |
| 4 | MSDA | Monitor Serial Data I/O, internal pull-up |
| 5 | MSCL | Monitor Serial Clock input |
| 6 | VDD | Supply pad VDD (battery, positive terminal) |
| 7 | VSS | Common ground (battery, negative terminal) |
| 8 | VSS | Common ground (battery, negative terminal) |
| 9 | P17 | General purpose I/O (or digital modulator output) |
| 10 | P15 | General purpose I/O or external clock |
| 11 | P14 | General purpose I/O (or digital modulator output) |
| 12 | IN1 | LF receiver channel 1, positive input |
| 13 | IN2 | LF receiver channel 1, negative input |
| 14 | IN3 | LF receiver channel 2, positive input |

Table 6.1 Pin Description

6.4 Marking

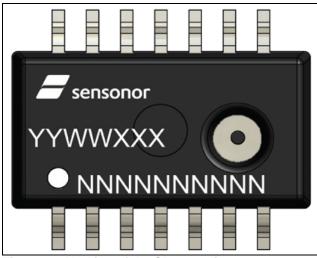


Figure 6.8 Marking of the SP300 series

The variables in Figure 6.8 have the following meaning:

| YYWWXXX : | Lot |
|------------|-----|
| NNNNNNNNN: | Pro |
| O: | Pin |

ot number Product name Pin 1 Marking